

The innovative dispensing system that increases throughput and yield via significant gains in speed, accuracy, and flexibility.



# Camalot

XyflexPro®+ Dispensing System
The industry's most flexible dispensing platform

## Camalot

## XyflexPro<sup>+</sup>

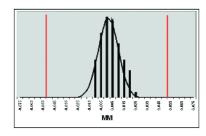
Traditional dispensing platform specifications usually indicate only X-Y repeatability and/or dot placement accuracy. While valid, this data neglects important deviations that can be associated with positional error on a given machine. Total System Accuracy is the only means to determine this.

#### Real-World Measurements of Increased Accuracy and Speed

Going beyond current standards, Speedline has developed a more comprehensive, accurate gauge of a dispensing system's positional capability. With Camalot's XyflexPro+platform, a critical new specification was introduced: Total System Accuracy (TSA). Representative of real-world production, TSA measures material placement accuracy relative to a target at full system speed.

TSA is a compilation of the following factors:

- XY positioning accuracy
- · Camera calibration/Vision resolution
- Camera to needle/dispense nozzle offset calculation



XY Placement Accuracy +/- 38 microns @ 3

	sigma
XY Repeatability	+/- 10 microns @ 3
	sigma
Total System Accuracy	+/-50 microns @ 3
	sigma

#### PUMP HIGHLIGHTS

#### Dot DU

- Ideally suited for adhesives, epoxies and solder paste
- · Uses footed or unfooted needles
- · Precise material delivery
- Minimal maintenance



#### Line DU

- · Ideally suited for underfill and encapsulants
- Uses patented no-drip design
- · Carbide parts as standard
- · High flow rates



#### Ideally suited for lower viscosity material <50000 cps)</li>

- Patented continuous flow piston design means zero recharge time
- · Carbide pump components resist wear from filed materials
- 10cc to 6oz. cartridges direct mount to the pump
- Positive displacement design ensures volume output remains constant as material viscosity changes



#### • New, non-contact dispense pump is well-suited for underfill applications

- Patent pending design uses a positive displacement technique to create a "Stream" of material
- Closed-loop servo drive ensures fast, repeatable performance
- · Innovative design eliminates mechanical ball-to-seat contact, thus reducing wear on parts
- Narrow stream width for access into densely packed areas

#### SmartStream®

		Dot DU	Line DU	MPP	SmartStream
	Non Contact Stream				Х
	Auger Screw	Х	Х		
	Piston			Х	X
FEATURES	Carbide	*x	Х	Х	X
	Positive Shut-Off		Х		
	Low Level Sensor	Х	X	Х	X
	Heat		Х	Х	Х
	SMT Glue	Х			_
	Solder Paste	Х			
DDOOFCC	Silver Epoxy	Х			
PROCESS	Edge/Corner Bond	Х	Х	Х	Х
	Underfill/Encapsulation		Х	Х	Х
	Dam		Х		

<sup>\*</sup> Optional

#### A Heritage of Innovation

With over 45 patents issued to date, we're committed to inventing improvements that benefit our customers. These patents include:

Patent No. Title
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		_
6,514,569	Variable Volume	
	Positive Displaceme	ent
	<b>Dispensing System</b>	&
	Method – MPP	

6,541,063 Calibration of Dispensing System — Patented Pattern Weigh Routine

6,739,483 Liquid Dispensing System with Improved Sealing Auger Screw — Positive Shutoff

6,775,879 Needle Cleaner

6,814,810 Method & Apparatus for Controlling a Dispensing System — Weight Scale

#### Accuracy + Speed + Flexibility + Configurability

The XyflexPro<sup>+</sup> platform represents a synergy of four elements key to a superior dispensing system: accuracy, speed, flexibility, and configurability. Its many product features each deliver multiple user benefits.

The system's unique design architecture allows XyflexPro<sup>+</sup> to be retrofitted in the field with any option, anytime. This offers the user optimum adaptability for future applications — a must for a rapidly changing environment. Coupled to this is an unmatched ability to change back and forth from SMT to semiconductor applications with minimum downtime.

**Dual-Mode Weight Scale** 

Patented closed-loop weighing process allows measurement of both global and actual dispense patterns for maximum accuracy. Changes in material viscosity are controlled with automatic compensation.

The XyflexPro<sup>+</sup> system incorporates patented dispensing technologies in its Multi-Piston Pump, positive shut-off dispense units, and SmartStream pump. All dispense pumps incorporate a quick-release mechanism, allowing fast and easy changeovers.

Combining these advances with Speedline's proprietary Camalot Benchmark® software delivers superior ease of use and the ability to precisely control dispense volumes, resulting in a system with unparalleled performance.

#### **Advanced Pump Technology**

A wide range of auger, multi-piston and non contact pumps are offered to meet an array of users' manufacturing requirements.

#### **Needle Cleaner/Detector**

Vacuum-based cleaning station ensures cleanliness of needle/nozzle. A detector is used to verify needle straightness and presence, compatible with 12–32 gage needles.

## Gantry Structure Rigid composite

Rigid composite design utilizes linear motors and encoders, giving calibration-free operation in the most demanding production environments.

#### **Part Handling**

Configurable transport system allows up to three conveyor zones that can support contact or non-contact heat chucks and SMT edge clamps. Design enables quick changeover between configurations.



Speedline

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CAMALOT XyflexPro <sup>+</sup> S	SDECIEICATIONS
SMT Applications	SMA, solder paste, conductive
Sivit Applications	adhesives
Semiconductor/Packaging	Underfill, encapsulant, thermal
Seriiconductor/Tackaging	grease, lid seal, die attach
	- Grouse, ila seai, ale attaon
XY AXIS	
XY Placement Accuracy*	+/- 38 microns (0.0015") @ 3 sigma
Z Axis Accuracy*	+/- 12.7 microns (0.0005") @ 3
	sigma
Repeatability*	+/- 10 microns @ 3 sigma
Speed	750 mm/s (29.5"/sec)
Acceleration	1.5 g
Encoder Resolution	1 micron
Gantry Drive System	Linear motor/encoders
Total System Accuracy (TSA)*	+/- 50 microns (0.002") @ 3
CpK > 1.0	sigma ————————————————————————————————————
Z AXIS	
Z Axis Acuracy*	+/- 12.7 microns (0.0005") @ 3
	sigma
Repeatability*	+/- 5 microns @ 3 sigma
Speed	Up to 220 mm/s (8.7"/sec)
Acceleration	Up to 3.7 g
Encoder Resolution	1.4 micron
Z Axis Type	Closed-loop dc servo, ballscrew
	drive
Z Sense Type	Mechanical probe or CCD laser
DOT DI ACEMENT DEDECOMANIC	<u> </u>
3.00 mm Pitch**	
1.27 mm Pitch**	45,000 dph 50,000 dph
IPC 9850 Test PCB**	35,000 dph
TRAVEL	
Max Dispense Area (XY)***	Up to 559 mm x 559 mm (22" x 22")
Z Axis Travel	29 mm (1.14")
BOARD HANDLING	
Conveyor Type	Flat belt with auto-width adjust
Minimum Conveyor Width	25.4 mm (1.0")
Above-Board Clearance	25.4 mm (1.0")
Underboard Clearance	30.5 mm (1.2")
Transport Height	790 mm to 965 mm (32.1" to 38")
Protocol	SMEMA
Conveyor Options SMT	SMT edge clamps with vacuum
Converse Lift Observe	support
Conveyor Lift Chucks	Up to three 13" x 10" chucks
Conveyor Weight Capacity***	3.66 kg total (8.1 lbs)
Lift Chuck Options	w/3 lift chucks
Lift Chuck Options	Heated contact w/ vacuum or
Chuck Temperature Pange	non-contact (convection)  Ambient to 130°C
Chuck Temperature Range	Ambient to 130 C

DISPENSE METHOD		
Pump Temperature Range	Ambient to 70°C	
Pump Control	Closed-loop dc servo axis	
SmartStream	Non-contact, positive	
	displacement Streaming pump for	
	Underfill, low level sensor	
Dispense Unit (DU)	Rotary positive displacement, dot	
	DU, heated/unheated Line DU with	
	positive shut-off, low level sensor	
Multi-Piston Pump (Heated)	Standard or low-volume designs,	
	low level sensor	
STANDARD FEATURES		
Auto-Width Conveyor	XYZ calibration station	
Pre-dispense Station	Purge station	
Flip Chip Calculator	Auto-vision alignment	
Vision System	Split beam on-axis illumination —	
	red, or blue light	
Computer	Rack-mount industrial-grade	
	computer	
Operating System	Microsoft Windows XP	
Program Storage	Local hard drive, CD-RW, Ethernet	
	and USB ports	
Program Method	Teach camera, off-line	
	programming, or text file	
	download	
Pipeline conveyor	Parallel product transfer	
FACILITIES		
Power Requirements	200 to 250 Vac 50/60 Hz 20A	
Air Supply Requirements	10 cfm (4.7 l/sec) at >80 PSI	
	(5.5 bar) filtered at 5 microns	
Machine Footprint	1270 mm x 1440 mm x 1529 mm	
(W x D x H)	(50" x 56.7" x 60.2")	
Machine Weight	1100 kg (2425 lb)	
Crated Weight	1221 kg (2690 lb)	
Industry Standards	CE, SMEMA, SEMI S2 & S8	
OPTIONS		
Dual Mode Weight Scale	Die edge detection algorithms	
Needle Cleaner	Needle Detector	
Secondary Z Axis		
*At full rated speed  ** 0.5 mm dot diameter, 2.5 mm needle lift  *** Consult factory for specifics.		
Electronic data sheet available on request. Specifications are subject to change without notice.		

#### ABOUT SPEEDLINE TECHNOLOGIES

Speedline Technologies is the global leader in process knowledge and expertise for the PCB assembly and semiconductor industries. Based in Franklin, Massachusetts, U.S.A., the company markets five best-in-class brands — Accel microelectronics cleaning; Camalot dispensing systems; Electrovert wave soldering, reflow soldering, and cleaning equipment; MPM stencil and screen printing systems; and Protect global services, support, and training solutions. For more information, visit us at www.speedlinetech.com.

Speedline Technologies maintains an ongoing program of product improvement that may affect design and/or price. We reserve the right to make these changes without prior notice or liability.